查询"2SK37623供应商Field Effect Transistor Silicon N Channel MOS Type (兀MOS)

2SK3762

Switching Regulator Applications

T**USHIBA**

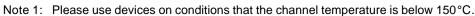
- Low drain-source ON resistance: RDS (ON) = 5.6 (typ.)
- High forward transfer admittance: $|Y_{fs}| = 2.0 \text{ S}$ (typ.)
- Low leakage current: $I_{DSS} = 100 \ \mu A (V_{DS} = 720 \text{ V})$
- Enhancement-mode: $V_{th} = 2.0 \sim 4.0 V (V_{DS} = 10 V, I_D = 1 mA)$

Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit |
|--|------------------------------|------------------|---------|------|
| Drain-source voltage | | V _{DSS} | 900 | V |
| Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) | | V _{DGR} | 900 | V |
| Gate-source voltage | | V _{GSS} | ±30 | V |
| | DC (Note 1) | I _D | 2.5 | А |
| Drain current | Pulse (t = 1 ms) (Note 1) | l _{DP} | 7.5 | |
| Drain power dissipation (Tc = 25°C) | | PD | 62 | W |
| Single pulse avalanche energy (Note 2) | | E _{AS} | 21.6 | mJ |
| Avalanche current | | I _{AR} | 2.5 | А |
| Repetitive avalanche energy (Note 3) | | E _{AR} | 6.2 | mJ |
| Channel temperature | | T _{ch} | 150 | °C |
| Storage temperature range | | T _{stg} | -55~150 | °C |

Thermal Characteristics

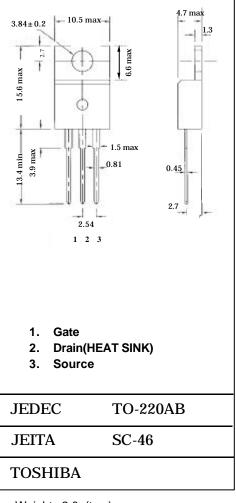
| Characteristics | Symbol | Max | Unit |
|--|------------------------|------|------|
| Thermal resistance, channel to case | R _{th (ch-c)} | 2.02 | °C/W |
| Thermal resistance, channel to ambient | R _{th (ch-a)} | 83.3 | °C/W |

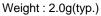


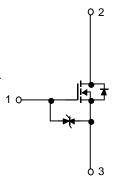
Note 2: $V_{DD} = 90 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}, \text{ L} = 6.3 \text{ mH}, \text{ I}_{AR} = 2.5 \text{ A}, \text{ R}_{G} = 25 \Omega$

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.







unit : mm

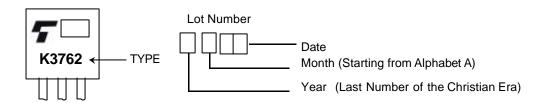
Erectrica Character istics (Ta = 25°C)

| Char | acteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-------------------------------|-----------------|----------------------|--|-----|------|-----|------|
| Gate leakage current | | Igss | $V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$ | _ | — | ±10 | μΑ |
| Gate-source breakdown voltage | | V (BR) GSS | $I_D = \pm 10 \ \mu A, \ V_{GS} = 0 \ V$ | ±30 | — | _ | V |
| Drain cut-off cur | rent | loss | $V_{DS} = 720 V, V_{GS} = 0 V$ | _ | | 100 | μA |
| Drain-source bre | eakdown voltage | V (BR) DSS | $I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$ | 900 | | | V |
| Gate threshold v | oltage | V _{th} | $V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$ | 2.0 | | 4.0 | V |
| Drain-source ON | l resistance | R _{DS (ON)} | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.5 \text{ A}$ | | 5.6 | 6.4 | Ω |
| Forward transfer | admittance | Y _{fs} | $V_{DS} = 20 V, I_D = 1.5 A$ | 1.0 | 2.0 | _ | S |
| Input capacitance | | C _{iss} | V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz | | 470 | _ | pF |
| Reverse transfer capacitance | | C _{rss} | | _ | 10 | _ | |
| Output capacitance | | C _{oss} | | _ | 50 | _ | |
| Switching time | Rise time | t _r | V_{GS} $0 V$ V_{GS} $0 V$ $F_{L} = 1.5 A$ $R_{L} = 133 \Omega$ $V_{DD} \simeq 200 V$ | _ | 20 | _ | ns |
| | Turn-on time | t _{on} | | _ | 60 | _ | |
| | Fall time | t _f | | | 30 | _ | |
| | Turn-off time | t _{off} | Duty \leq 1%, t _w = 10 µs | | 100 | _ | |
| Total gate charge | | Qg | | — | 12 | _ | |
| Gate-source charge | | Q _{gs} | $V_{DD}{\simeq}400$ V, $V_{GS}{=}10$ V, $I_{D}{=}2.5$ A | | 7 | | nC |
| Gate-drain charge | | Q _{gd} |] | | 5 | | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

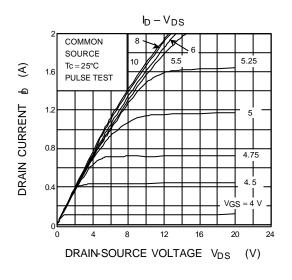
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--|------------------|---|-----|------|------|------|
| Continuous drain reverse current (Note 1) | I _{DR} | — | _ | _ | 2.5 | А |
| Pulse drain reverse current (Note 1) | D RP | — | _ | _ | 7.5 | А |
| Forward voltage (diode) | V _{DSF} | $I_{DR} = 2.5 \text{ A}, V_{GS} = 0 \text{ V}$ | _ | _ | -1.7 | V |
| Reverse recovery time | t _{rr} | $I_{DR} = 2.5 \text{ A}, V_{GS} = 0 \text{ V},$ | | 720 | _ | ns |
| Reverse recovery charge | Q _{rr} | dl _{DR} /dt = 100 A/µs | _ | 3.6 | _ | μC |

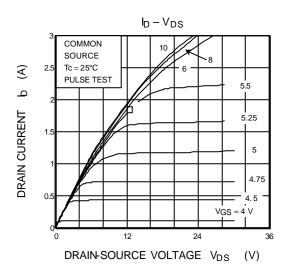
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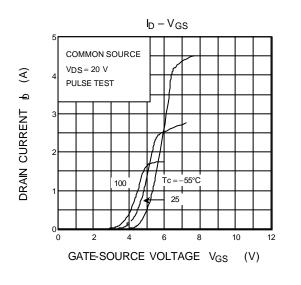


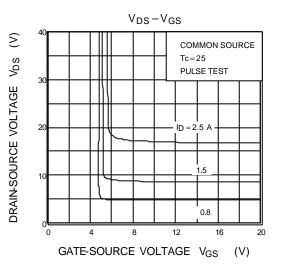
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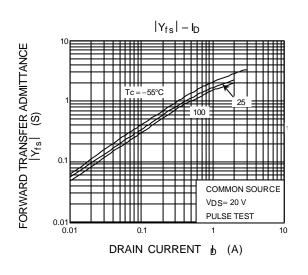
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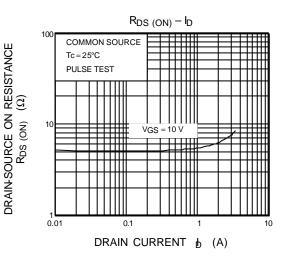






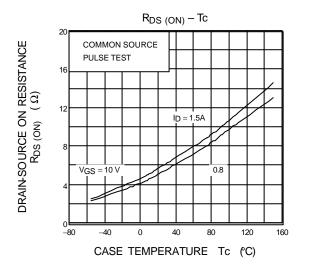


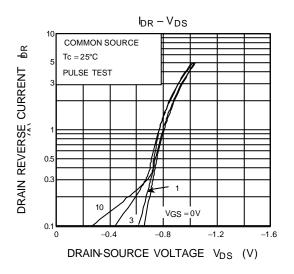


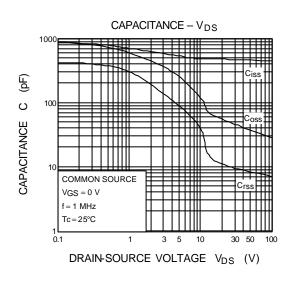


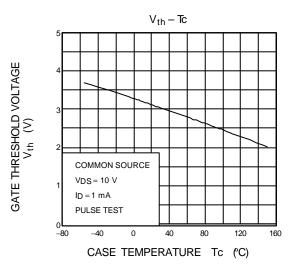
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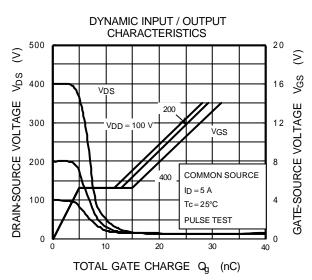
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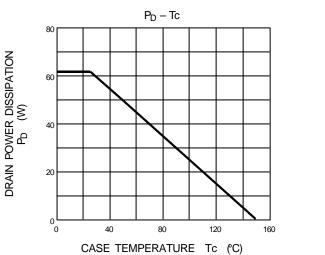






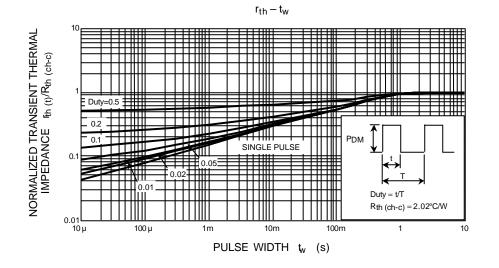


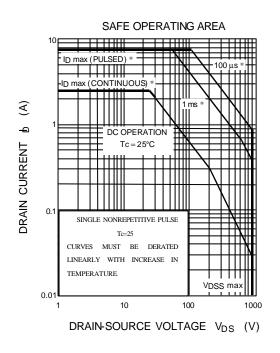


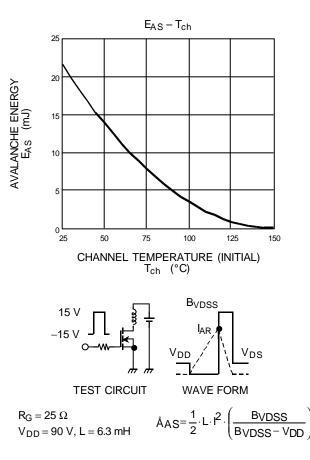


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